

Appl. No. 10/563,778
Election dated May 21, 2008
Reply to Restriction Requirement of 04/29/2008
Attorney Docket No. 1217-053827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/563,778 Confirmation No. 3140
Applicant : Naoya SAIKI
Filed : January 6, 2006
Title : Hardenable Pressure Sensitive Adhesive Sheet for
Dicing/Die-Bonding and Method for Manufacturing
Semiconductor Device
Art Unit : 4191
Examiner : Christopher C. Caillouet
Customer No. : 28289

ELECTION AND AMENDMENT

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated April 29, 2008, please amend the
above-identified application as follows:

Election of Claims begins on page 2 of this paper.

Amendments to the Specification begin on page 3 of this paper.

Remarks begin on page 5 of this paper.

I hereby certify that this correspondence is being submitted
electronically in the United States Patent and Trademark
Office on the date set forth below.

Diane Paull

(Name of Person Mailing Paper)

Diane Paull
Signature

05/21/2008
Date

ELECTION

The Examiner required restriction under 35 U.S.C. §121 as follows:

Group I: Claims 1-6 and 8-12, drawn to a pressure-sensitive adhesive sheet; and

Group II: Claims 7 and 13-17, drawn to a process for producing semiconductor devices.

Applicant hereby elects for further prosecution the invention of Group I including claims 1-6 and 8-12, drawn to a pressure-sensitive adhesive sheet.

Applicant reserves the right to file at a later time a divisional application directed to the non-elected process claims.